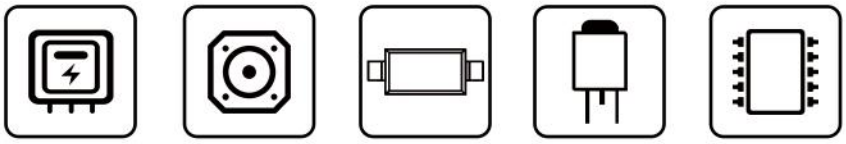
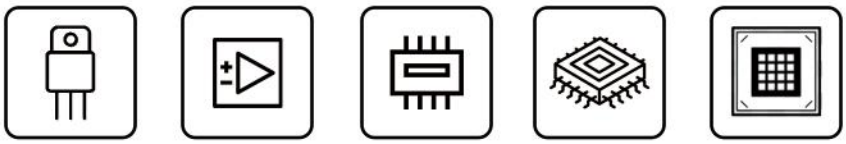
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SS310

產品規格說明書

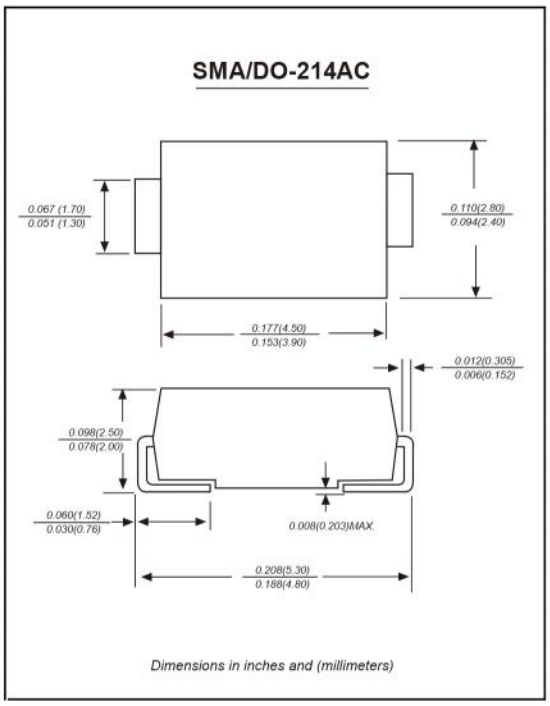
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SS310

3.0Amp Surface Mount Schottky Barrier Rectifiers

Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Low reverse leakage
- Built-in strain relief,ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed: 250°C/10 seconds at terminals



Mechanical Data

Case: JEDEC DO-214AC molded plastic body
Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
Polarity: Color band denotes cathode end
Mounting Position: Any
Weight: 0.002 ounce, 0.07 grams

Maximum Ratings And Electrical Characteristics

Ratings at 25℃ ambient temperature unless otherwise specified. Single phase half-wave 60Hz,resistive or inductive load, for capacitive load current derate by 20%.

	SYMBOLS	SS32	SS34	SS36	SS38	SS310	SS315	SS320	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	20	40	60	80	100	150	200	VOLTS
Maximum RMS voltage	V_{RMS}	14	28	42	56	70	105	150	VOLTS
Maximum DC blocking voltage	V_{DC}	20	40	60	80	100	150	200	VOLTS
Maximum average forward rectified current at T_A=75°C	$I_{(AV)}$	3.0							Amp
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	80.0							Amps
Maximum instantaneous forward voltage at 3.0A	V_F	0.55		0.70		0.85		0.95	Volts
Maximum DC reverse current T_A=25℃	I_R	0.5						0.2	mA
at rated DC blocking voltage T_A=100℃		20.0				10.0		2.0	
Typical thermal resistance (NOTE 1)	$R_{\theta JA}$	70.0							C/W
Operating junction temperature range	T_J	-55 to +125				-55 to +150			°C
Storage temperature range	T_{STG}	-55 to +150							°C

Note: 1.P.C.B. mounted with 8.0x8.0mm copper pad areas

Ratings And Characteristic Curves

FIG. 1- FORWARD CURRENT DERATING CURVE

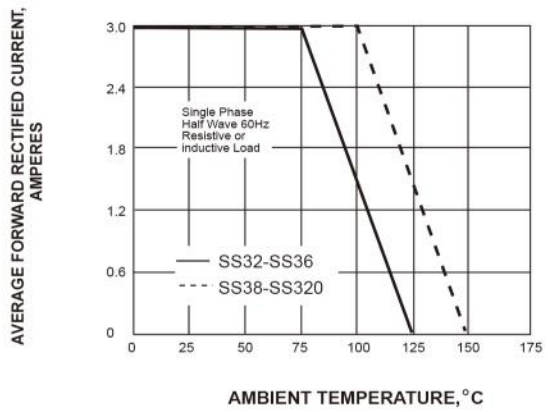


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

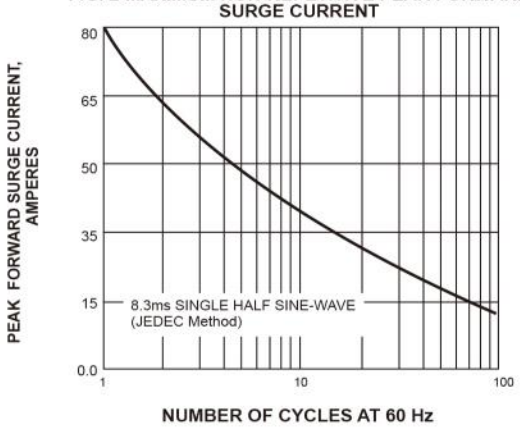


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

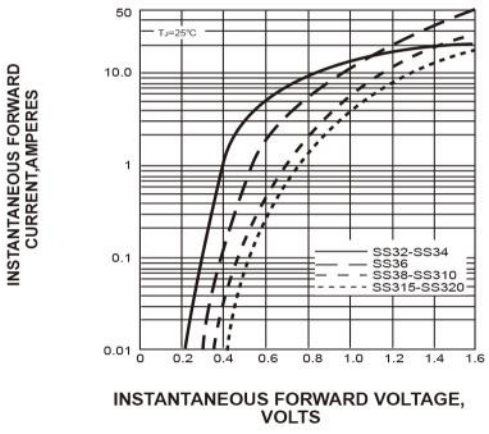


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

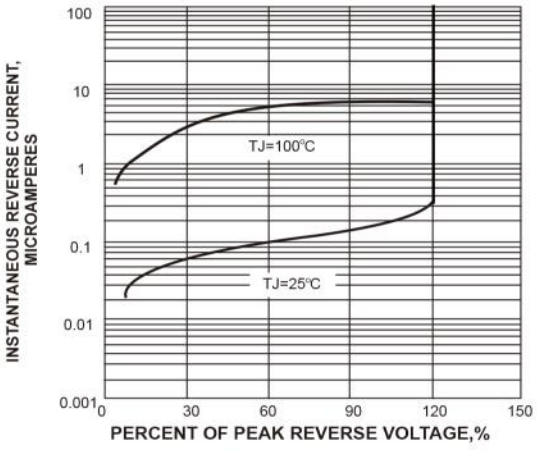


FIG. 5-TYPICAL TRANSIENT THERMAL IMPEDANCE

